# RClamp0544T RailClamp®

## **Ultra Low Capacitance TVS Arrays**

## PROTECTION PRODUCTS - RailClamp®

### Description

RailClamps® are ultra low capacitance TVS arrays designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by **ESD** (electrostatic discharge), **CDE** (Cable Discharge Events), and **EFT** (electrical fast transients).

The RClamp®0544T has a typical capacitance of only 0.30pF between I/O pins. This allows it to be used on circuits operating in excess of 3GHz without signal attenuation. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge). Each device is designed to protect four lines (two differential pairs).

The RClamp0544T is in a 8-pin, RoHS/WEEE compliant, SLP2010P8T package. It measures  $2.0 \times 1.0 \times 0.4$ mm. The leads are spaced at a pitch of 0.4mm and are finished with lead-free NiPdAu. They are designed for easy PCB layout by allowing the traces to run straight through the device. The combination of small size, low capacitance, and high level of ESD protection makes them a flexible solution for applications such as mini HDMI, MDDI, USB, and eSATA interfaces.

### **Features**

- ♦ ESD protection for high-speed data lines to IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC 61000-4-5 (Lightning) 5A (8/20μs) IEC 61000-4-4 (EFT) 40A (5/50ns)
- Package design optimized for high speed lines
- Flow-Through design
- Protects four I/O lines
- ◆ Low capacitance: **0.3pF** typical (I/O to I/O)
- Low clamping voltage
- Low operating voltage: 5V
- Solid-state silicon-avalanche technology

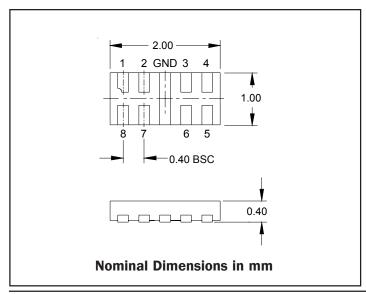
#### **Mechanical Characteristics**

- ◆ SLP2010P8T 8-pin package (2.0 x 1.0 x 0.4mm)
- ◆ RoHS/WEEE Compliant
- Lead Pitch: 0.4mm
- Lead finish: NiPdAu
- Marking: Marking code + date code
- Packaging: Tape and Reel

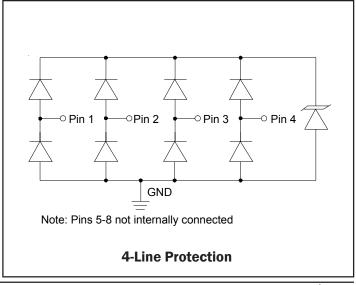
### **Applications**

- Cell Phones and Accessories
- Mini HDMI
- MDDI Ports
- ◆ USB
- ◆ LVDS
- eSATA
- PCI Express

### **Dimensions**



## Circuit Diagram





## Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20µs)	$P_{pk}$	75	Watts
Peak Pulse Current (tp = 8/20µs)	I <sub>PP</sub>	5	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V <sub>ESD</sub>	+/- 18 +/- 12	kV
Operating Temperature	T,	-55 to +125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

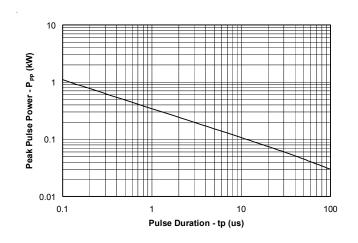
## Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	Pin 1, 2, 3, or 4 to GND			5	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>t</sub> = 1mA, Pin 1, 2, 3, or 4 to GND	6.5	8	11	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5.0V, Pin 1, 2, 3, or 4 to GND		0.005	0.100	μΑ
Clamping Voltage	V <sub>c</sub>	$I_{pp} = 1A$ , tp = 8/20µs Pin 1, 2, 3, or 4 to GND			12	V
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> = 5A, tp = 8/20μs Pin 1, 2, 3, or 4 to GND			15	V
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = 0V, f = 1MHz, Pin 1, 2, 3, or 4 to GND		0.7	0.80	pF
		V <sub>R</sub> = 0V, f = 1MHz, Between I/O pins		0.3	0.4	рF

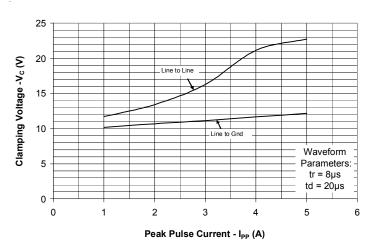


### Typical Characteristics

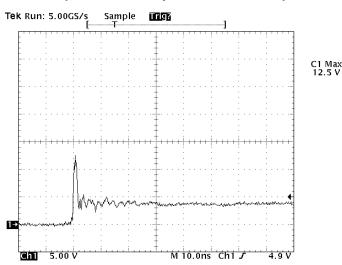
#### Non-Repetitive Peak Pulse Power vs. Pulse Time



#### **Clamping Voltage vs. Peak Pulse Current**

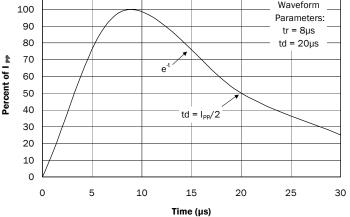


### ESD Clamping (Pin 1, 2, 3, or 4 to GND) (+8kV Contact per IEC 61000-4-2)



Note: Data is taken with a 10x attenuator

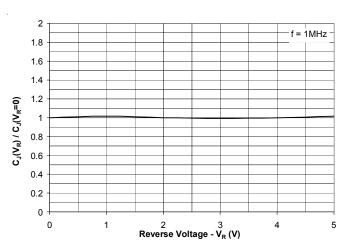




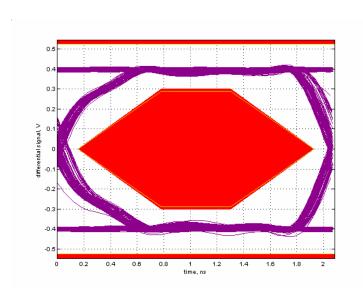
**Pulse Waveform** 

110

#### Normalized Capacitance vs. Reverse Voltage



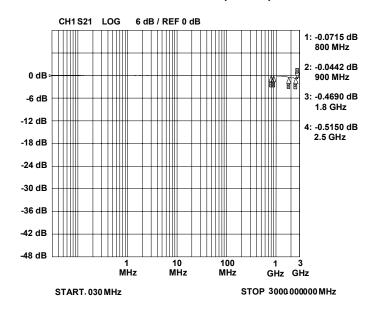
USB 2.0 Eye Pattern with RClamp0544T



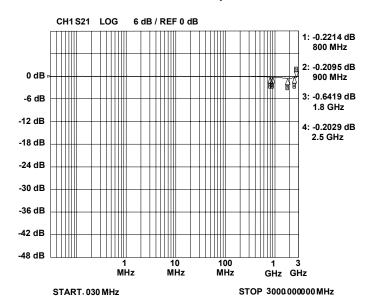


### Typical Characteristics (Con't)

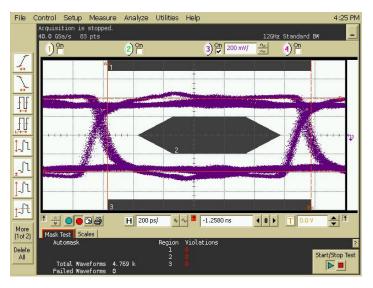
#### Insertion Loss S21 - I/O to I/O



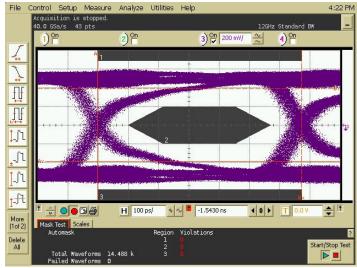
#### Insertion Loss S21 - I/O to GND



#### **HDMI Eye Pattern (720p with RClamp0544T)**



### HDMI Eye Pattern (1080p with RClamp0544T)





### **Applications Information**

#### **Design Recommendations for HDMI Protection**

Adding external ESD protection to HDMI ports can be challenging. First, ESD protection devices have an inherent junction capacitance. When adding even a small amount of capacitance, it will cause the impedance of the differential pair to drop. Second, large packages and land pattern requirements can cause discontinuities that adversely affect signal integrity. The RClamp0544T is specifically designed for protection of high-speed interfaces, such as HDMI. It presents <0.3pF capacitance between the pairs while being rated to handle >±8kV ESD contact discharges (>±15kV air discharge) as outlined in IEC 61000-4-2. The device is in a leadless SLP package that is less than 1.1mm wide. It is designed such that the traces flow straight through the device. The narrow package and flow-through design reduce discontinuities and minimize impact on signal integrity. This becomes even more critical as signal speeds increase.

#### **Pin Configuration**

Figure 2 is an example of how to route the high speed differential traces through the RClamp0544T. The PCB traces are used to connect the pin pairs for each line (pin 1 to pin 8, pin 2 to pin 7, pin 3 to pin 6, pin 4 to pin 5). For example, line 1 enters at pin 1 and exits at Pin 8, and the PCB trace connects pin 1 and 8 together. This is true for lines connected at pins 2, 3, and 4 also. Note that there are no internal connections to pins 5 - 8. Ground is connected at the center tabs. One large ground pad should be used in lieu of two separate pads.

#### TDR Measurements for HDMI

The combination of low capacitance, small package, and flow-through design means it is possible to use these devices to meet the HDMI impedance requirements of 100 Ohm  $\pm 15\%$  without any PCB board modification.

For signal integrity purposes, the best results will be obtained by using the RClamp0544T to protect the high-speed differential pairs. This is because the device is designed such that the data lines from the connector line up with the I/O pins of the device without altering the trace routing.

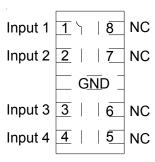


Figure 1 - SLP2010P8T Pin Configuration (Top View)

Pin	Identification
1, 2, 3, 4	Input Lines
5, 6, 7, 8	Output Lines (No Internal Connection)
Center Tab	Ground

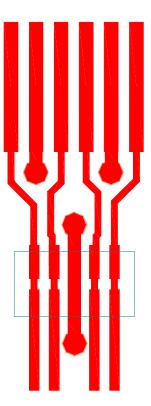
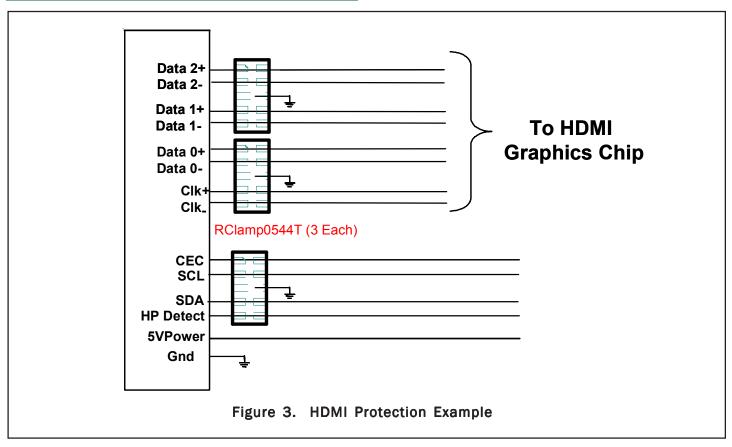
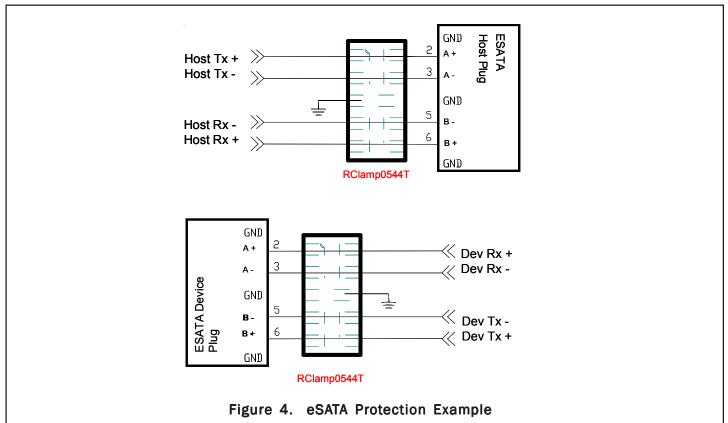


Figure 2 - Flow through Layout Using RClamp0544T



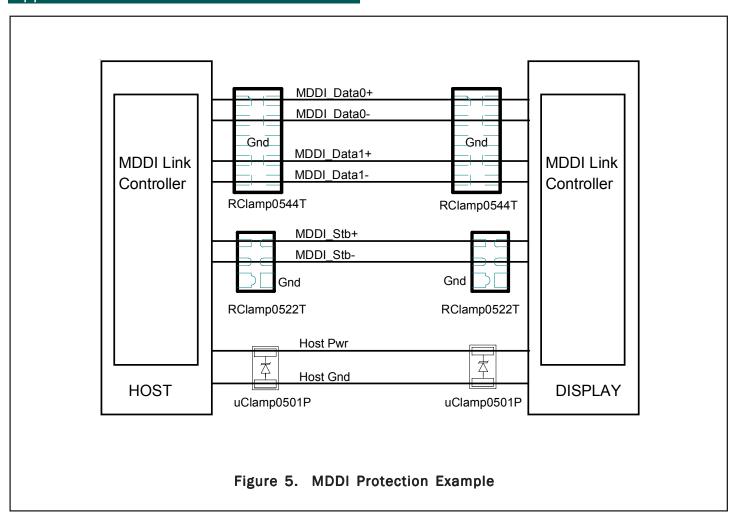
## **Applications Information**





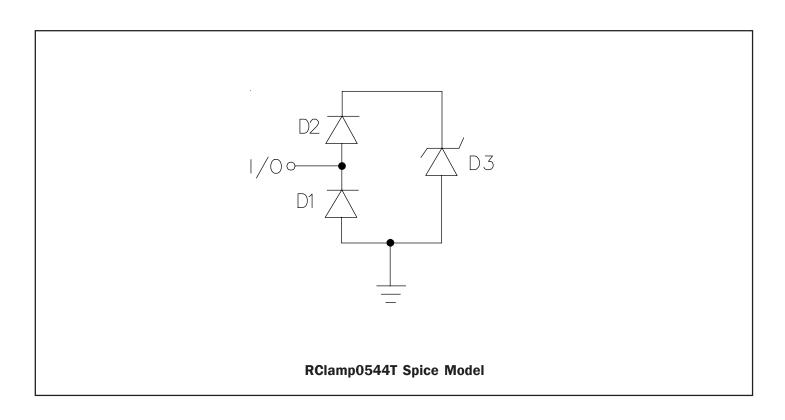


## Applications Information





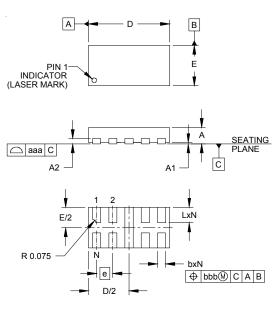
# Applications Information - Spice Model



RClamp0544T Spice Parameters									
Parameter	Unit	D1	D2	D3					
IS	Amp	1E-20	1E-20	2E-12					
BV	Volt	100	100	8.2					
٧J	VJ Volt		0.83	0.6					
RS	Ohm	m 1.5 0.6	0.6	0.2					
IBV	Amp	1E-3	1E-3	1E-3					
CJO	Farad	0.25E-12	0.25E-12	56E-12					
TT	sec	2.541E-9	2.541E-9	2.541E-9					
M		0.01	0.01	0.23					
N		1.1	1.1	1.1					
EG	EG eV		1.11	1.11					



## Outline Drawing - SLP2010P8T

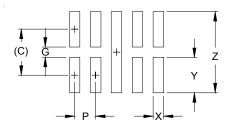


DIMENSIONS								
DIA	11	NCHE	S	MILL	IMET	ERS		
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	.015	.016	.017	0.37	0.40	0.43		
A1	0.00	.001	.002	0.00	0.02	0.05		
A2		(.005)			(0.13)			
b	.006	.008	.010	0.15	0.20	0.25		
D	.077	.079	.082	1.95	2.00	2.08		
Е	.037	.039	.043	0.95	1.00	1.08		
е	.0	16 BS	C	0.40 BSC				
L	.013	.015	.017	0.32	0.38	0.43		
N		8		8				
aaa		.003		0.08				
bbb		.004		0.10				

#### NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

### Land Pattern - SLP2010P8T



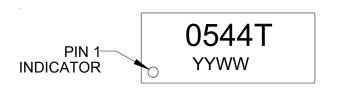
	DIMENS	SIONS				
DIM	INCHES	MILLIMETERS				
С	(.035)	(0.88)				
G	.008	0.21				
Р	.016	0.40				
X	.008	0.20				
Υ	.026	0.67				
Z	.061	1.55				

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- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.



### Marking Codes



## Ordering Information

Part Number	Qty per Reel	Reel Size
RClamp0544T.TCT	3000	7 Inch

RailClamp and RClamp are marks of Semtech Corporation

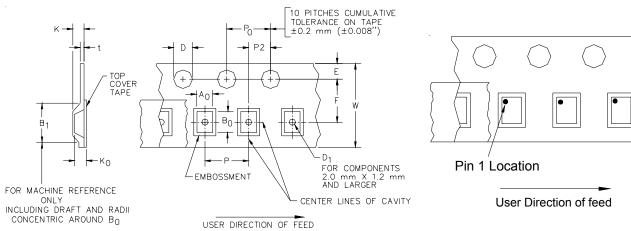
YYWW = Date Code

Α0

### Tape and Reel Specification

В0

K0



#### **Device Orientation in Tape**

1.21 +/-0.05 mm 2.21 +/-0.05 mm		mm (	0.66 +/-0.05 mm	n							
Tape Width	B, (Max)	D	D1	E	F	K (MAX)	Р	PO	P2	T(MAX)	W
8 mm	4.2 mm	1.5 + 0.1 mm - 0.0 mm )	0.5 mm ±0.05	1.750±.10 mm	3.5±0.05 mm	2.4 mm	4.0±0.1 mm	4.0±0.1 mm	2.0±0.05 mm	0.4 mm	8.0 mm + 0.3 mm - 0.1 mm

### **Contact Information**

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